

FY2014 Annual General Meeting Presentation to shareholders

17th October 2014

Harnessing Our Strengths :





Safe Harbor

This presentation and the following discussion may contain forward looking statements by Ellipsiz Ltd. ("Ellipsiz") relating to financial trends for future periods.

Some of the statements contained in this presentation or arising from this discussion which are not of historical facts are statements of future expectations with respect to financial conditions, results of operations and businesses, and related plans and objectives. Such forward looking statements are based on Ellipsiz's current views and assumptions including, but not limited to, prevailing economic and market conditions and currently available information. These statements involve known and unknown risks and uncertainties that could cause actual results, performance or achievements to differ materially from those in the forward looking statements. Such statements are not, and should not be construed, as a representation (express or implied) as to future performance or achievements of Ellipsiz. In particular, such statements should not be regarded as a forecast or projection of future performance of Ellipsiz and must not be relied upon for any particular purpose whatsoever. It should be noted that the actual performance or achievements of Ellipsiz may vary significantly from such statements.







Harnessing Our Strengths :



We successfully sustained our **Fifth consecutive year** of operational profitability and achieved improved results for FY2014... with



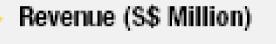
Improvement came mainly from better revenue mix but was partly offset by additional expenses incurred by the newly acquired operations, the increase in R&D expenses and incurrence of net finance expenses.

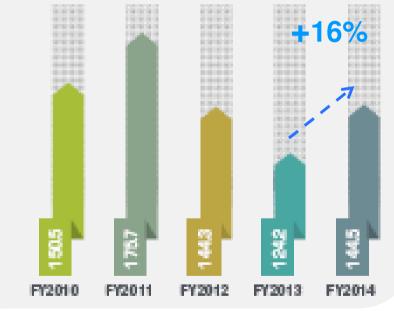




FY2014 Revenue improved by 16% to \$144.5 Million

Revenue improved amidst the Group's resolve to streamline & consolidate business activities over past years and the acquisition of probe card business assets that was completed in early part of FY2014. Growth was contributed mainly by 83% increase in PCS revenue.

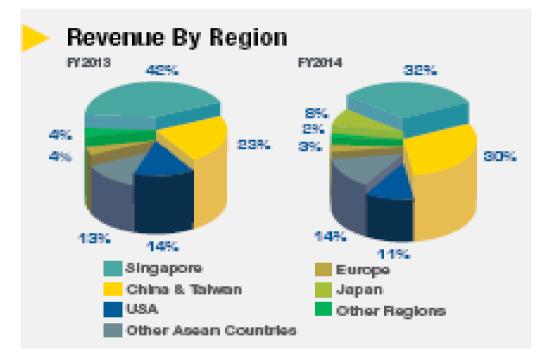




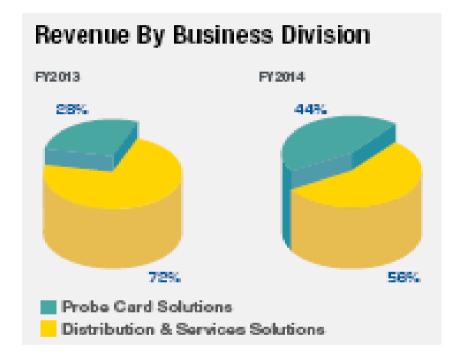




FY2014 Revenue



The Acquisition in FY2014 had increased the revenue from Japan and Taiwan.



The improved performance by our Probe Card Solutions had increased its contribution to Group's revenue from 28% in FY2013 to 44% in FY2014





FY2014 NPATMI & NPATMI excluding Specific Items improved

Financial year ended 30 June

RESULTS (in \$ million)	2013	2014
Net Profit after tax and non-controlling interests	4.8	13.5
Net Profit after tax and non-controlling interests excluding certain specific items ⁽¹⁾	5.0	6.4

Net profit improved by 183% to \$13.5 million during FY2014 and included one-time net gains of \$7.1 million⁽¹⁾. Excluding one-time net gains, net profit from operations grew by 28% to \$6.4 million.

(1) Specific items refer to certain items that are identified to be excluded as they are not expected to recur. During the year, the Group had one time specific net gains of \$7.1 million mainly relating to the business acquisition. The one-time specific net gains of \$7.1 million includes negative goodwill income of \$13.2 million less acquisition cost of \$1.1 million, post-acquisition integration cost of \$4.6 million, provision of retrenchment cost of \$0.3 million and loss on disposals of subsidiaries of \$0.1 million.



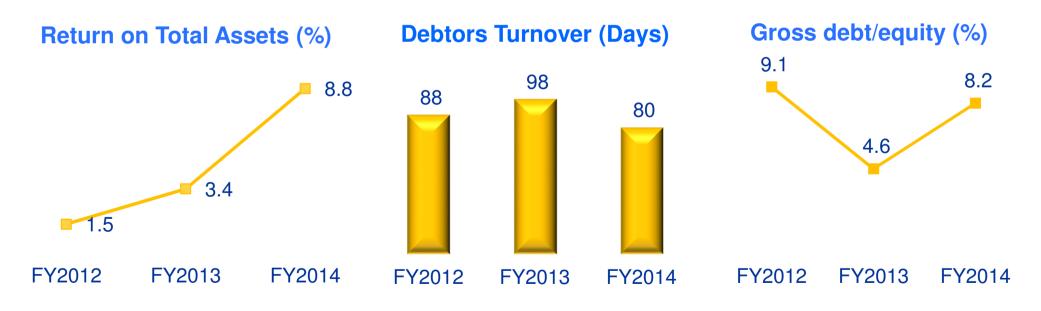


Improved Profitability

Financial Year ended 30 June	2013	2014
Gross Profit Margin %	24.7	26.9
Profit Before Tax Margin %	3.3	9.6
Net Earnings Margin %	3.8	9.4
Return on Equity %	4.6	11.6

Healthy Balance Sheet

Financial Year ended 30 June	2013	2014
Current ratio (times)	2.3	2.2
Quick ratio (times)	2.0	1.9
Cash and cash equivalents \$ million	32.4	32.0
NAV per share (cents)	18.9	21.1







Dividends

0.54 [®]	
CENTS	
DMIDEND PER SHARE FOR FY2014	

o +170% Dividend Payout

 Increase from 0.20 cents/share in FY2013 to 0.54 cents/per share in FY2014

Interim Dividend	0.18 cents / share (declared and paid after H1 results)
Final Dividend ⁽¹⁾	0.18 cents / share
Final Special Dividend ⁽¹⁾	0.18 cents / share

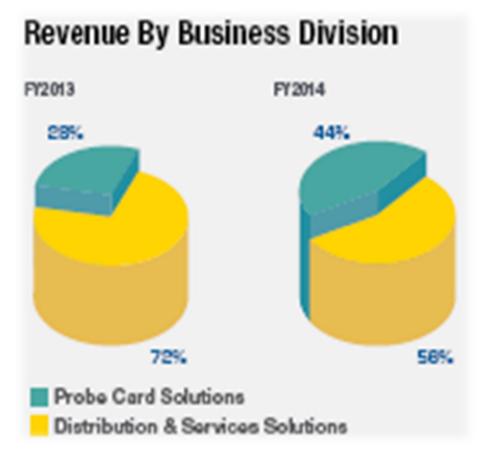
⁽¹⁾ Subject to approval of shareholders during 19th AGM. If approved will be payable on **13 November 2014**





FY2014 M&A Highlights

- During the year, our Probe Card Solutions (PCS) acquired assets and IP of Tokyo Cathode Laboratory to expand regional coverage & product lines. This Acquisition helps the Group to establish strong operational base in Japan and Taiwan. It also enhanced the product portfolio of PCS, now serving new markets, specifically LCD and CIS.
- The newly acquired activities added \$22 million revenue to the Group in FY2014.
- To enable focus of our resources on core activities, the Group made tough decisions to divests the investments in facilities and communication activities.



Harnessing Our Strengths : Global Footprint



- Acquisition has expanded not Ο just distribution presence in Japan and strengthened our positioning in Taiwan, it has added new manufacturing facilities to our Probe Card Solutions
- The Acquisition has also Ο strengthened our engineering team with the ability to combine knowhow in US and Japan.

FY2014 M&A Highlights



Harnessing Our Strengths : Well-Positioned Facilities





Probe Card Solutions

In FY2014,



(+83% Y-o-Y)

 Although the semiconductor market improved in 2013, the weakness of the Japanese Yen caused a slight decline in the overall probe card market of 2% in 2013 (VLSIresearch, April 2014).

oPCS Revenue growth driven by the increasing demand for advanced technologies and the assets acquisition of Tokyo Cathode Laboratory.

 PCS Advanced Probe Card products continue to show strong growth driven by smartphone, tablet and power-management applications.

Harnessing Our Strengths : Products, Technologies & Services





Probe Card Solutions (Continued)

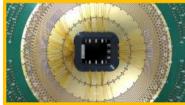
- Acquired assets & IP of Tokyo Cathode Laboratory to expand regional coverage & products
 - Established strong operational base in Japan, thus, allowing PCS to gain entrance into Japan
 - Enhanced product portfolio, now serving new markets, specifically LCD and CIS
- PCS also recognized by VLSIresearch as:
 - #2 Best Supplier of Test Consumables & named as a member of THE BEST Subsystems suppliers



- PCS excelled in the Commitment and Partnering categories
 - Received high scores for Quality of Results and Support After Sales.
 - PCS praised for customer-focused approach, flexibility and drive to find solutions.



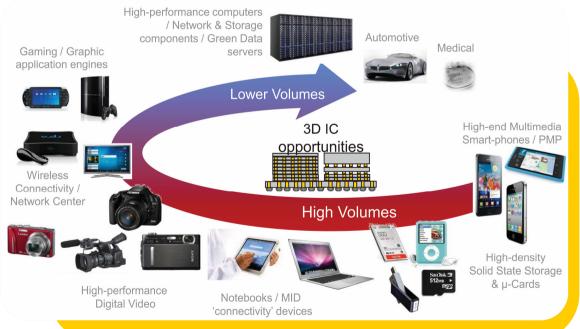






Probe Card Solutions (Continued)

- PCS continues to invest in enhancing existing probe card technologies especially probing applications for Copper Pillar which are driving our Advanced Probe Card business
- Copper Pillar addresses both high volume ICs for end products such as tablets and smartphones and low volume ICs utilized in automotive and medical applications.
- Currently our LogicTouch[™] FPV and Trio[™] Vertical are used for these new types of ICs.
- Copper Pillar Probe card market requirements include 20K+ probes, low force, pitch at 80µm.
- PCS developing an 80µm probe for lower force, full array Copper Pillar applications.



Harnessing Our Strengths : Products, Technologies & Services



Distributions & Services Solutions

\$82M

In FY2014,

Segment Revenue (-9% Y-o-Y)

- DSS revenue fell due mainly to lower revenue from facilities activities.
 - Pressures from uncertain market, pricing, limited capex opportunities and competitive alternatives impacted activities
- Recurring revenue faced challenging growth but supported the overall revenue base
- DSS continues to integrate its North & South Asia operations to enhance revenue, response and relevancy to market dynamics
 - Search and evaluate new business partners in terms of product technologies and versatilities to fortify stronghold of partners, customers and solutions offerings

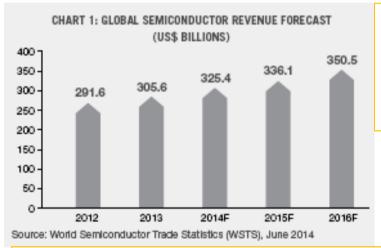
Harnessing Our Strengths : Products, Technologies & Services





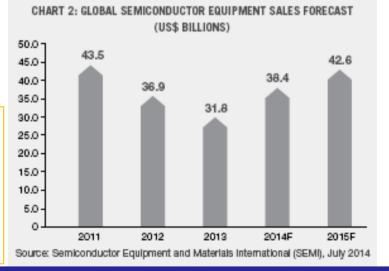
Industry Outlook

We are cautiously optimistic of our operating and performance prospects for FY2015



The global semiconductor market is forecast to grow 6.5% to US\$325 billion in 2014; 3.3% to US\$336 billion in 2015 and 4.3% to US\$350 billion in 2016 as all product categories are expected to grow on assumption of macro economic recovery. Asia Pacific is expected to reach about US\$207 billion in 2016. (Source: WSTS, June 2014)

The worldwide semiconductor equipment sales is projected to grow 20.8% in 2014 to US\$38 billion and 10.8% in 2015 to US\$43 billion, driven by investments at foundry and logic fabs for sub-20nm technology, NAND flashmakers for leading technology capacity, DRAM technology upgrades for mobile applications, and expansion of advanced packaging for flip chip, wafer bumping, and wafer level packaging. (Source: SEMI, July 2014)

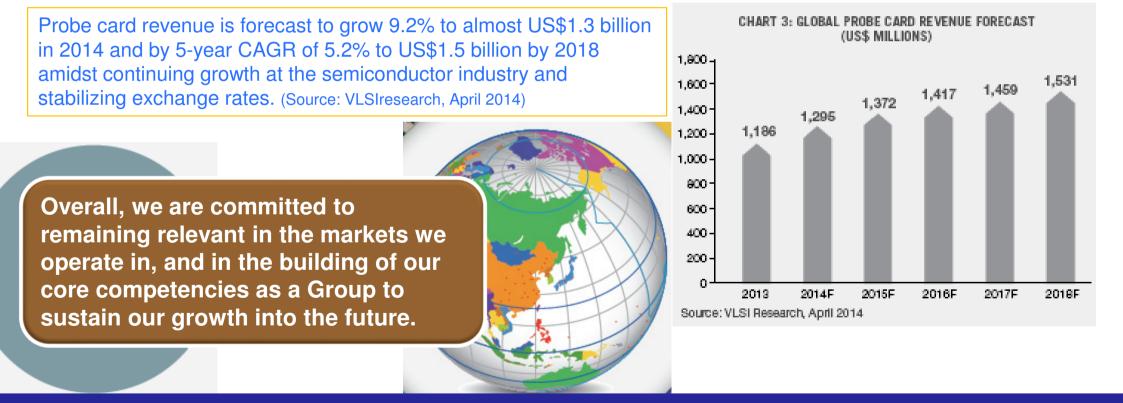


Harnessing Our Strengths :



Industry Outlook

We are cautiously optimistic of our operating and performance prospects for FY2015



Harnessing Our Strengths :





We will continue with the **harnessing** of our **core**

strengths namely global footprint,

technological edge, well-positioned facilities

and **stable financial position** that have always

fortified our market position.

Harnessing Our Strengths :

Thank you! www.ellipsiz.com

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